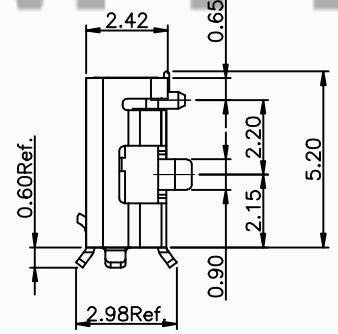
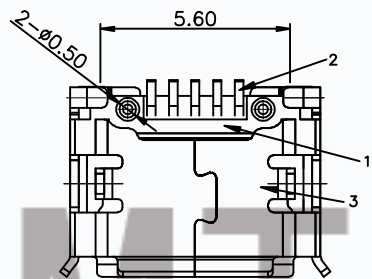


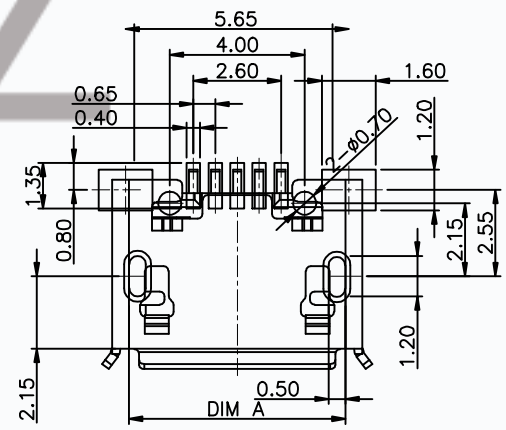
NOTES:

1. 成品功能要求面不可有端子压伤及塑胶毛边。
2. 标有“▲”记号者为重点检验尺寸。
3. 未标注尺寸公差为依自由公差为准。
4. 成品端子平面度必须100%检验。



NOTES:

1. MATERIAL:  
HOUSING: THERMOPLASTIC HIGH-TEMP UL94V-0 BLACK COLOR.  
CONTACT: COPPER ALLOY.  
SHELL: C2680 1/2H.
2. FINISH:  
CONTACT: 50u"~80u" Ni/G.F PLATED OVER ALL.  
SHELL: 50u"~80u"Ni/80u"MIN. MATTE Tin PLATED OVER ALL.
3. APPLIED TO IR SOLDERING PROCESS.
4. SPECIFICATION:  
4.1.ELECTRICAL CHARACTERISTICS  
CONTACT CURRENT RATING: 1A MIN.  
VOLTAGE RATING: 30V AC rms.  
CONTACT RESISTANCE: 30mΩ MAX.  
DIELECTRIC WITHSTANDING VOLTAGE:  
UNMATEP CONTACT 100V AC rms. 60MHZ FOR 1 MINUTE.  
INSULATION RESISTANCE: 1000MΩ MIN. 100V DC  
TEMPERATURE RANGE: -20°C TO +85°C  
4.2.MECHANICAL:  
INSERTION FORCE: 35N MAX.  
WITHDRAWAL FORCE: 8N MIN.  
DURABILITY: 10,000 CYCLES



RECOMMENDED PCB LAYOUT(TOP VIEW)  
GENERAL TOLERANCES: ±0.05

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				mm	USB			
DIM TOL DIM TOL X. ±0.35 X° ±1° X.X ±0.25 X.X° ±0.5° X.XX ±0.15 X.XX° X.XXX ±0.10 X.XXX°				MAT'L	MODEL NO.	TITLE: MICRO USB 5P/F B-TYPE 间距(6.65) 引脚长(0.4) 物料		
				材质	T10-05FB04			
FINISH				APPD:	DWG NO: CMTD03-00903-03-565-5P-S01			
				硬度				CHKD:
Q'TY				DR:	WJ	11/9'12	数量	
				数量				

SCALE	SHEET	REV.
1/1	页特	版本